

Attachment B
SMBC GLOBAL FOUNDATION, INC.
SCHOLARSHIP APPLICATION FORM

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I. Personal Information

Applicant's Name: _____
Present Address : _____
Street / P.O. Box Address _____

City / Town	State / Province	Country	Zip / Postal Code
Permanent Address : _____			
Street / P.O. Box Address _____			

City / Town	State / Province	Country	Zip / Postal Code
Country Code and Telephone Number : _____			
Date of Birth : _____		Sex : M _____ F _____	
Place of Birth : _____		Ethnic Background : _____ (Voluntary)	

Marital Status : _____
Country of Citizenship : _____
Class of Standing During Scholarship Year : _____
First
Second
Third
Fourth
Graduate (Specify year __)

Academic Department / Faculty : _____ Degree Sought : _____
Would you prefer to be contacted at your Present Address ☐ or your Permanent Address ☐?
Please provide an email address where you can be reached: _____

Statement of Financial Need

Please attach to this application an explanation of your financial need.

II. Family Information

Father's Name: _____
Present Address : _____
Street / P.O. Box Address _____

City / Town	State / Province	Country	Zip / Postal Code
College and Degrees : _____			
Occupation : _____			
Employer (Company Name) : _____			
Mother's Name: _____			
Present Address : _____			
Street / P.O. Box Address _____			

City / Town	State / Province	Country	Zip / Postal Code
College and Degrees : _____			
Occupation : _____			
Employer (Company Name) : _____			

III. Education

List all secondary schools, colleges, universities, graduate and professional schools attended

(starting with the most recent):

Institution	Location	Dates Attended From / to	Degree and Date Received	Major

List academic honors, awards, prizes or other academic recognition received :

List your extracurricular and community activities, including any positions held and honors or awards received, in order of importance to you:

Organization	Position Held (elected or appointed ?)	Dates from / to

Please attach to this application your high school transcript and your latest available transcript (if any) from the University.

IV. **Employment/Internship Experience**

If applicable, and beginning with your most recent position, please complete the following information on your employment experience, including any military service, since high school.

Include any significant part-time or summer employment, and explain any gaps in employment. Include a current resume, if available, but please complete this form.

A. Employer (Company Name) : _____
Address : _____
Telephone Number : _____
Nature of Business : _____ Title or position held : _____
Dates : From : _____ To : _____ Ending Salary : _____
Responsibilities : _____
Reason for Leaving : _____
B. Employer (Company Name) : _____
Address : _____
Telephone Number : _____
Nature of Business : _____ Title or position held : _____
Dates : From : _____ To : _____ Ending Salary : _____
Responsibilities : _____
Reason for Leaving : _____

V. Additional Information Required

Essays :

1. Describe on an attached sheet any hobbies or activities which hold specific significance for you (limit to 300 words).
2. Describe on an attached sheet why you choose to pursue an academic or professional degree in this Department / Faculty (limit to 300 words).

References :

1. Name : _____ Address : _____
Telephone Number : _____ Relationship : _____
2. Name : _____ Address : _____
Telephone Number : _____ Relationship : _____
3. Name : _____ Address : _____
Telephone Number : _____ Relationship : _____

Do you or any of your relatives have any connection to the University (other than as a student), SMBC Global Foundation, Inc., Sumitomo Mitsui Banking Corporation, Sumitomo Mitsui Financial Group, the Institute of International Education, or the China Scholarship Council? ☐ Yes ☐ No

If Yes, please explain : _____

VI. Certification and Release Authorization

I certify that the information set forth in this application (including attachments) is true, complete, and accurate. I authorize the release of any information necessary to confirm and / or verify this application :

Date : _____ Applicant's Signature : _____